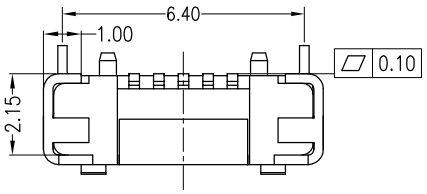
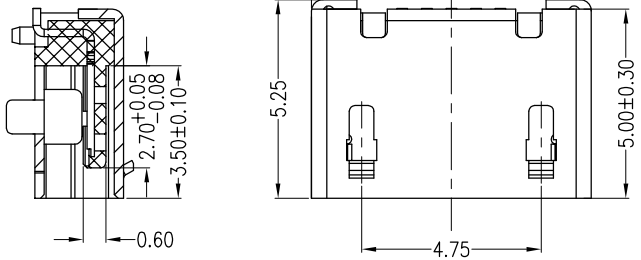
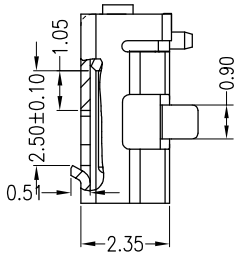
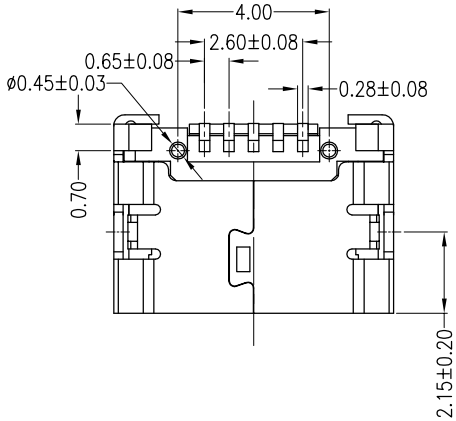
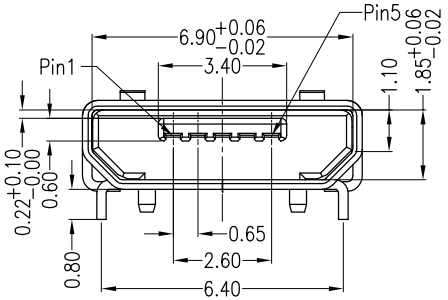
REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE

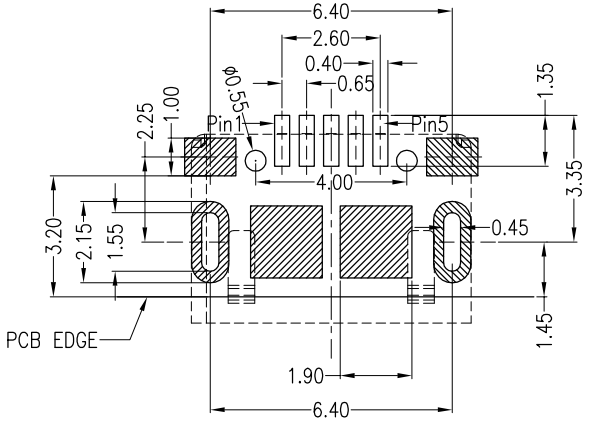












RECOMMANDED PCB LAYOUT

PCB图仅供参考

Note:
1.Material:
- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.20mm
- 1.3 Shell: copper alloy,t=0.25mm

2.Specification:
- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C

外壳材质
1:C2680R-H

外壳电镀
1:NiOu' '
2:雾TSOu' '
3:Ni+Au1u' ' (脚)
4:Au1u' '

端子电镀 01:Au1u' ';02:Au1.5u' ';03:Au3u' '
05:Au5u' ' ;10:Au10u' ';15:Au15u' ';30:Au30u' '

主体颜色 B:黑色

主体材质 1:LCP

端子材质 4:C5191R-EH

PART NO: USB-F06505-SC014		MATERAL: SEE NOTE	WFDCONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD
MODEL NO. XX		FINSH: SEE NOTE	
UNIT: MM	SIZE: A4	COLOR: SEE NOTE	TITLE: Micro usb 5s B Type有焊脚有柱(插板式)6.4无导位
TOLERANCE UNSPECIFIED .x 0.15 .xx 0.10 .xxx 0.05 Ang. 1°		DR: LIU MIAO	DWG NO: A069 REV: A
		CHK: SIMON	
		APP: DAVID	SCALE: 5:1 DATE: 2012.05.18